

EMIF03-SIM02F3

3-line IPAD[™], EMI filter including ESD protection

Features

- EMI symmetrical (I/O) low-pass filter
- High efficiency in EMI filtering
- Lead-free package
- Very low PCB space consuming: 1.2 mm²
- Very thin package: 0.60 mm
- High efficiency in ESD suppression
- High reliability offered by monolithic integration
- High reduction of parasitic elements through integration and wafer level packaging

Complies with the following standards

- IEC 61000-4-2 Level 4 on external and V_{cc} pins:
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- IEC 61000-4-2 Level 1on internal pins:
 - 2 kV (air discharge)
 - 2 kV (contact discharge)
- MIL STD 883E Method 3015-6 Class 3

Applications

EMI filtering and ESD protection for:

- SIM Interface (subscriber identify module)
- UIM Interface (universal identify module)

Description

The EMIF03-SIM02F3 is a highly integrated device designed to suppress EMI / RFI noise in all systems subjected to electromagnetic interferences.

This filter includes an ESD protection circuitry which prevents damage to the application when subjected to ESD surges up to 15 kV.



Figure 1. Pin configuration (bump side)



Figure 2. Configuration



TM: IPAD is a trademark of STMicroelectronics.

1 Electrical characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25 \ ^{\circ}C$)

Symbol	Parameter and test conditions	Value	Unit
V _{PP}	Internal pins (A3, B3, C3): ESD discharge IEC 61000-4-2, air discharge ESD discharge IEC 61000-4-2, contact discharge External pins (A2, B1, C2, C1): ESD discharge IEC 61000-4-2, air discharge ESD discharge IEC 61000-4-2, contact discharge	2 2 15 8	kV
Тj	Maximum junction temperature	125	°C
T _{op}	Operating temperature range	-40 to +85	°C
T _{stg}	Storage temperature range	-55 to 150	°C

Figure 3. Electrical characteristics (definitions)

Symb	ol	Parameter	.	
V _{BR}	=	Breakdown voltage	F	
I _{BM}	=	Leakage current @ V _{BM}		
V _{BM}	=	Stand-off voltage		, V _F
V _{CL}	=	Clamping voltage	V V V	/ .
I _{PP}	=	Peak pulse current		• • V
I _B	=	Breakdown current	I _R	
V _F	=	Forward voltage drop		
Cline	=	Line capacitance		
Ruo	=	Series resistance between Input and Output	L	

Table 2. Electrical characteristics ($T_{amb} = 25 \ ^{\circ}C$)

Symbol	Test conditions	Min.	Тур.	Max.	Unit
V _{BR}	I _R = 1 mA	6	-	20	V
I _{RM}	V _{RM} = 3 V	-	-	0.2	μA
R _d		-	1.5	-	Ω
R _{1,} R ₃	Tolerance ± 20%	-	100	-	Ω
R ₂	Tolerance ± 20%	-	47	-	Ω
C _{line}	$V_{\text{line}} = 0 \text{ V}, V_{\text{osc}} = 30 \text{ mV}, \text{ F} = 1 \text{ MHz}$	-	-	20	pF



Figure 4.



S21 (dB) attenuation measurement Figure 5. S21 (dB) attenuation measurement (A2-A3 line) (B1-B3 line)







Figure 8. Digital crosstalk measurements

0.00 db -10.00 -20.00 -30.00 -40.00 -50.00 -60.00 -70.00 -80.00 -90.00 F (Hz) -100.00 -1.0M 100.0k 10.0M 100.0M 1.0G Xtalka3/b1

Figure 9. Line capacitance versus reverse applied voltage (typical)



2 Aplac model





Figure 11. Aplac parameters

aplacvar Ls 950pH					
aplacvar Rs 150m	Dint1	Dext1	Dint2	Dext2	Dext3
aplacvar Cext1 12pF	BV=15	BV=15	BV=15	BV=15	BV=15
aplacvar Cext2 14pF	CJO=Cint1	CJO=Cext1	CJO=Cint2	CJO=Cext2	CJO=Cext3
aplacvar Cext3 18pF	IBV=1u	IBV=1u	IBV=1u	IBV=1u	IBV=1u
aplacvar Cint1 4.5pF	IKF=1000	IKF=1000	IKF=1000	IKF=1000	IKF=1000
aplacvar Cint2 4pF	IS=10f	IS=10f	IS=10f	IS=10f	IS=10f
aplacvar Rbump 17m	ISR=100p	ISR=100p	ISR=100p	ISR=100p	ISR=100p
aplacvar Lbump 43pH	N=1	N=1	N=1	N=1	N=1
aplacvar Rgnd 500m	M=0.3333	M=0.3333	M=0.3333	M=0.3333	M=0.3333
aplacvar Lgnd 50pH	RS=0.29	RS=0.25	RS=0.31	RS=0.28	RS=0.25
aplacvar Cgnd 0.15pF	VJ=0.6	VJ=0.6	VJ=0.6	VJ=0.6	VJ=0.6
aplacvar Rsub 100m	TT=50n	TT=50n	TT=50n	TT=50n	TT=50n





Figure 12. Voltages when IEC 61000-4-2 (+15 kV air discharge) applied to external pin

Figure 13. Voltages when IEC 61000-4-2 (- 15 kV air discharge) applied to external pin





3 Ordering information scheme





4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.













Ordering information 5

Ordering information Table 3.

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF03-SIM02F3	HA	Flip Chip	1.74 mg	5000	Tape and reel 7"

Note:

More information is available in the application notes: AN2348: "STMicroelectronics 400 micro-metre Flip Chip: package description and recommendation for use" AN1751: "EMI filters: recommendations and measurements"





6 Revision history

Table 4.Document revision history

Date	Revision	Changes
19-Jul-2005	1	Initial release.
26-Feb-2007	2	Changed out to ext in Configuration diagram on page 1. Added Ecopack statement. Reformatted to current layour standard. Updated Application note AN2348 reference and description.
28-Nov-2007	3	Updated ECOPACK statement. Updated <i>Figure 14</i> , <i>Figure 15</i> , <i>Figure 16</i> and <i>Figure 18</i> . Reformatted to current standards.
09-Feb-2010	4	Updated die dimensions in <i>Figure 15</i> and pocket dimensions in <i>Figure 18</i> .
07-Apr-2010	5	Updated tolerance dimensions in <i>Figure 15: Package dimensions</i> .



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